

More details he

GPU A+ Server AS -8125GS-TNHR

DP AMD 8U System with NVIDIA HGX H100/H200 8-GPU

Key Applications

High Performance Computing, AI/Deep Learning Training, Industrial Automation, Retail, Climate and Weather Modeling,

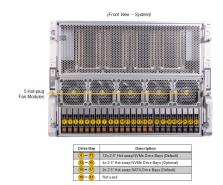
Key Features

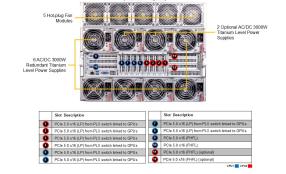
- High density 8U system for NVIDIA[®] HGX[™] H100/H200 8-GPU
 Highest GPU communication using NVIDIA[®] NVLINK[™] + NVIDIA[®] NVSwitch[™]
 8 NIC for GPU direct RDMA (1:1 GPU Ratio);
- 24 DIMM slots DDR5; up to 6TB 4800MT/s ECC LRDIMM/RDIMM;
- Up to 8 PCIe 5.0 x16 LP + 4 PCIe 5.0 x16 FHFL slots;
- Flexible networking options;
- 12 Hot-swap 2.5" NVMe drive bays + 2 hot-swap 2.5" SATA drive bays
 + 4 hot-swap 2.5" NVMe drive bays (optional)
 1 M.2 NVMe for boot drive only;
- 10 heavy duty fans with optimal fan speed control;
- 6x 3000W redundant Titanium level power supplies;



| Form Factor | 8U Rackmount |
|--------------------------|---|
| | Enclosure: 437 x 355.6 x 843.28mm (17.2" x 14" x 33.2") |
| | Package: 698 x 750 x 1300mm (27.5" x 29.5" x 51.2") |
| Processor | Dual processor(s) |
| | AMD EPYC™ 9004/9005 Series Processors |
| | (* AMD EPYC [™] 9005 Series drop-in support requires board revision 2.x) |
| | Up to 128C/256T |
| GPU | Max GPU Count: Up to 8 onboard GPUs |
| | Supported GPU: NVIDIA SXM: HGX H100 8-GPU (80GB), HGX H200 8-GPU (141GB) |
| | CPU-GPU Interconnect: PCIe 5.0 x16 CPU-to-GPU Interconnect |
| | GPU-GPU Interconnect: NVIDIA® NVLink® with NVSwitch™ |
| System Memory | Slot Count: 24 DIMM slots |
| | Max Memory (1DPC): Up to 6TB 4800MT/s ECC DDR5 RDIMM |
| Drive Bays Configuration | Default: Total 18 bays |
| | 2 front hot-swap 2.5" SATA drive bays |
| | 4 front hot-swap 2.5" NVMe* drive bays |
| | 12 front hot-swap 2.5" NVMe drive bays |
| | (*NVMe support may require additional storage controller and/or cables) |
| | M.2: 1 M.2 NVMe slot (M-key) |
| Expansion Slots | Default |
| | • 8 PCIe 5.0 x16 LP slots |
| | • 2 PCIe 5.0 x16 FHFL slots |
| | Option A |
| | • 8 PCIe 5.0 x16 LP slots |
| | • 4 PCIe 5.0 x16 FHFL slots |
| On-Board Devices | AMD SP5 |
| nput / Output | 1 VGA port |







| System Cooling | Fans: 10 heavy duty fans with optimal fan speed control |
|-----------------------|---|
| Power Supply | 6x 3000W Redundant Titanium Level (96%) power supplies |
| ystem BIOS | BIOS Type: AMI 32MB SPI Flash EEPROM |
| lanagement | SuperCloud Composer; Supermicro Server Manager (SSM); Supermicro Update Manager (SUM); Supermicro |
| | SuperDoctor® 5 (SD5); Super Diagnostics Offline (SDO); Supermicro Thin-Agent Service (TAS); SuperServer |
| | Automation Assistant (SAA) New! |
| PC Health Monitoring | CPU: Monitors for CPU Cores, Chipset Voltages, Memory |
| - | 7 +1 Phase-switching voltage regulator |
| | FAN: Fans with tachometer monitoring |
| | Status monitor for speed control |
| | Temperature: Monitoring for CPU and chassis environment |
| | Thermal Control for fan connectors |
| Dimensions and Weight | Weight: Gross Weight: 225 lbs (102.1 kg) |
| - | Net Weight: 166 lbs (75.3 kg) |
| | Available Color: Black front & silver body |
| Operating Environment | Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F) |
| | Non-operating Temperature: -40°C to 60°C (-40°F to 140°F) |
| | Operating Relative Humidity: 8% to 90% (non-condensing) |
| | Non-operating Relative Humidity: 5% to 95% (non-condensing) |
| Motherboard | Super H13DSG-O-CPU-D |
| Chassis | CSE-GP801TS |